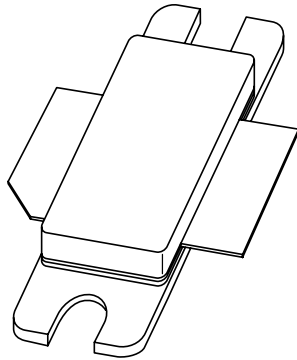


# DATA SHEET



## **BLL1214-250** L-band radar LDMOS transistor

Product specification  
Supersedes data of 2002 Aug 06

2003 Aug 29

## L-band radar LDMOS transistor

## BLL1214-250

## FEATURES

- High power gain
- Easy power control
- Excellent ruggedness
- Source on mounting base eliminates DC isolators, reducing common mode inductance.

## APPLICATIONS

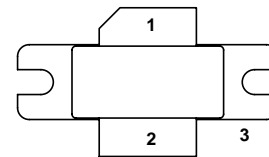
- L-band radar applications in the 1200 to 1400 MHz frequency range.

## DESCRIPTION

Silicon N-channel enhancement mode lateral D-MOS transistor encapsulated in a 2-lead flange package (SOT502A) with a ceramic cap. The common source is connected to the flange.

## PINNING - SOT502A

PIN	DESCRIPTION
1	drain
2	gate
3	source, connected to flange



Top view

MBK394

Fig.1 Simplified outline.

## QUICK REFERENCE DATA

RF performance at  $T_h = 25\text{ °C}$  in a common source test circuit.

MODE OF OPERATION	f (MHz)	$V_{DS}$ (V)	$I_{DQ}$ (mA)	$P_L$ (W)	$G_p$ (dB)	$\eta_D$ (%)	pulse droop (dB)	$t_r$ (ns)	$t_f$ (ns)
Pulsed class-AB; $t_p = 1\text{ ms}$ ; $\delta = 10\%$	1200 to 1400	36	150	250	>12	>42	<0.6	<100	<100

## LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
$V_{DS}$	drain-source voltage		–	75	V
$V_{GS}$	gate-source voltage		–	$\pm 22$	V
$P_{tot}$	total power dissipation	$T_h \leq 70\text{ °C}$ ; $t_p = 1\text{ ms}$ ; $\delta = 10\%$	–	400	W
$T_{stg}$	storage temperature		–65	150	°C
$T_j$	junction temperature		–	200	°C

## CAUTION

This product is supplied in anti-static packing to prevent damage caused by electrostatic discharge during transport and handling. For further information, refer to Philips specs.: SNW-EQ-608, SNW-FQ-302A and SNW-FQ-302B.

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## THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
$Z_{th\ j-h}$	thermal impedance from junction to heatsink	$T_h = 25\text{ °C}$ , note 1	0.17	K/W
$Z_{th\ j-h}$	thermal impedance from junction to heatsink	$T_h = 25\text{ °C}$ , note 2	0.32	K/W

## Notes

1. Thermal resistance is determined under RF operating conditions;  $t_p = 100\ \mu\text{s}$ ,  $\delta = 10\%$ .
2. Thermal resistance is determined under RF operating conditions;  $t_p = 1\ \text{ms}$ ,  $\delta = 10\%$ .

## CHARACTERISTICS

$T_j = 25\text{ °C}$  unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
$V_{(BR)DS}$	drain-source breakdown voltage	$V_{GS} = 0$ ; $I_D = 3\ \text{mA}$	75	–	–	V
$V_{GSth}$	gate-source threshold voltage	$V_{DS} = 10\ \text{V}$ ; $I_D = 300\ \text{mA}$	4	–	5	V
$I_{DSS}$	drain-source leakage current	$V_{GS} = 0$ ; $V_{DS} = 36\ \text{V}$	–	–	1	$\mu\text{A}$
$I_{DSX}$	on-state drain current	$V_{GS} = V_{GSth} + 9\ \text{V}$ ; $V_{DS} = 10\ \text{V}$	45	–	–	A
$I_{GSS}$	gate leakage current	$V_{GS} = \pm 20\ \text{V}$ ; $V_{DS} = 0$	–	–	1	$\mu\text{A}$
$g_{fs}$	forward transconductance	$V_{DS} = 10\ \text{V}$ ; $I_D = 10\ \text{A}$	–	9	–	S
$R_{DSon}$	drain-source on-state resistance	$V_{GS} = 9\ \text{V}$ ; $I_D = 10\ \text{A}$	–	60	–	$\text{m}\Omega$

## APPLICATION INFORMATION

RF performance in a common source class-AB circuit.  $T_h = 25\text{ °C}$ ;  $Z_{th\ mb-h} = 0.25\ \text{K/W}$ , unless otherwise specified.

MODE OF OPERATION	f (MHz)	$V_{DS}$ (V)	$I_{DQ}$ (mA)	$P_L$ (W)	$G_p$ (dB)	$\eta_D$ (%)	pulse droop (dB)	$t_r$ (ns)	$t_f$ (ns)
Pulsed class-AB; $t_p = 1\ \text{ms}$ ; $\delta = 10\%$	1200 to 1400	36	150	250	>12	>42	<0.6	<100	<100

## Ruggedness in class-AB operation

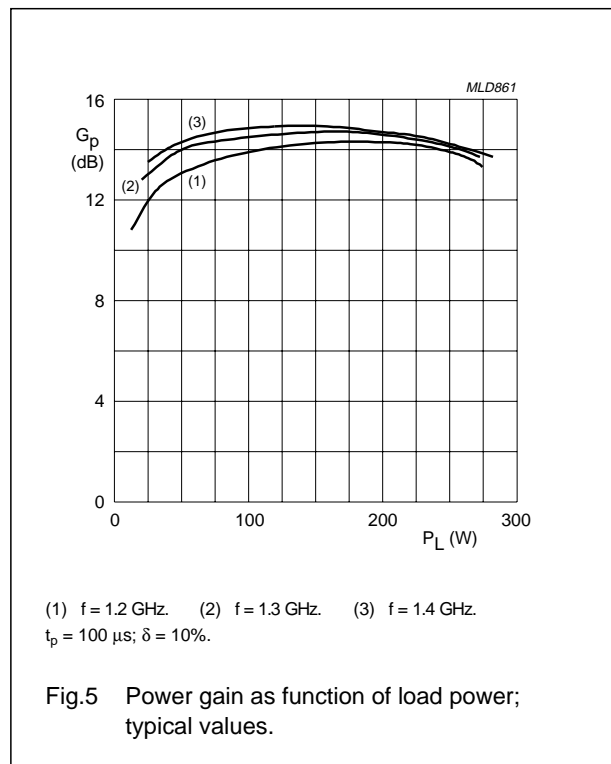
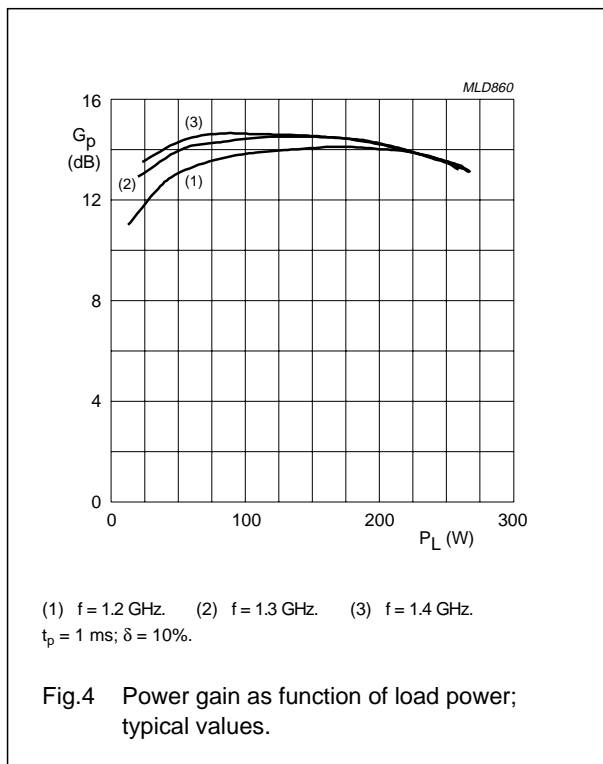
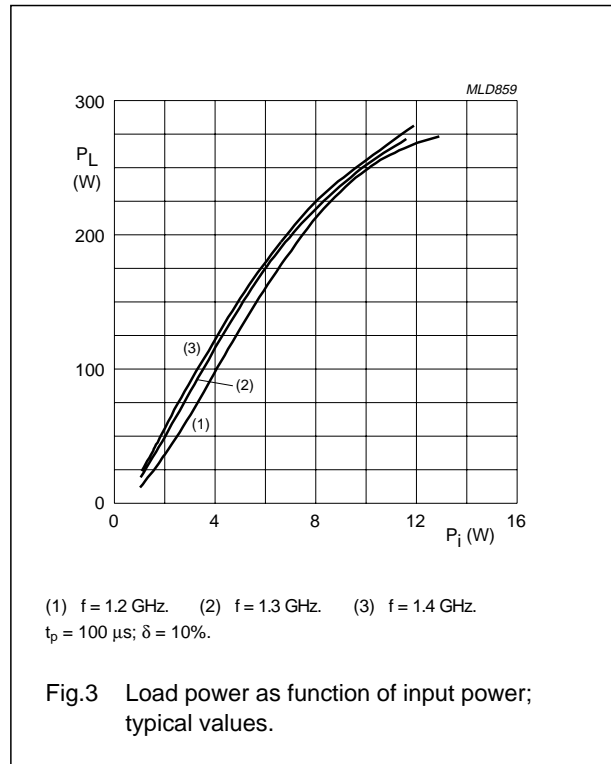
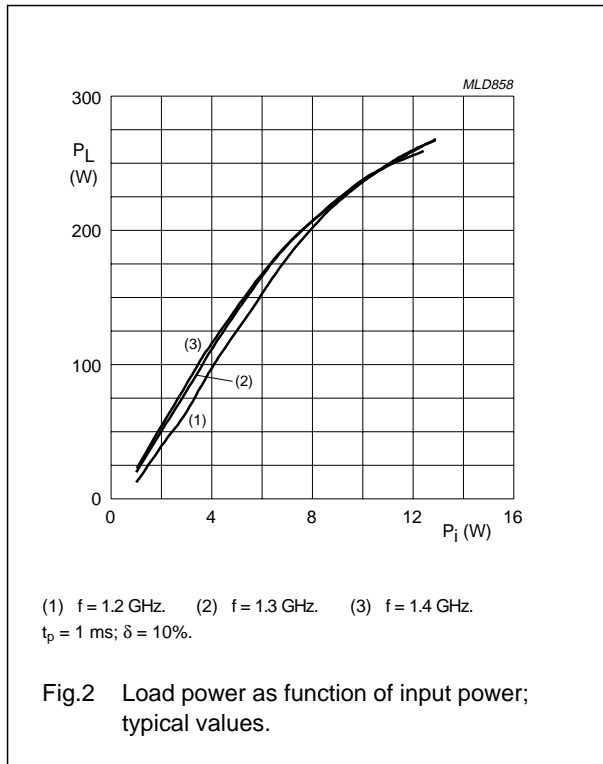
The BLL1214-250 is capable of withstanding a load mismatch corresponding to  $V_{SWR} = 3 : 1$  through all phases under the following conditions:  $V_{DS} = 36\ \text{V}$ ; frequency from 1200 MHz to 1400 MHz at rated load power.

## Typical impedance

FREQUENCY (GHZ)	$Z_s$ ( $\Omega$ )	$Z_L$ ( $\Omega$ )
1.20	1.3 – j 2.8	1.1 – j 0.9
1.25	1.9 – j 2.9	1.0 – j 0.5
1.30	4.6 – j 2.9	0.8 – j 0.2
1.35	5.7 – j 0.3	0.7 – j 0.3
1.40	2.7 – j 1.8	0.6 – j 0.4

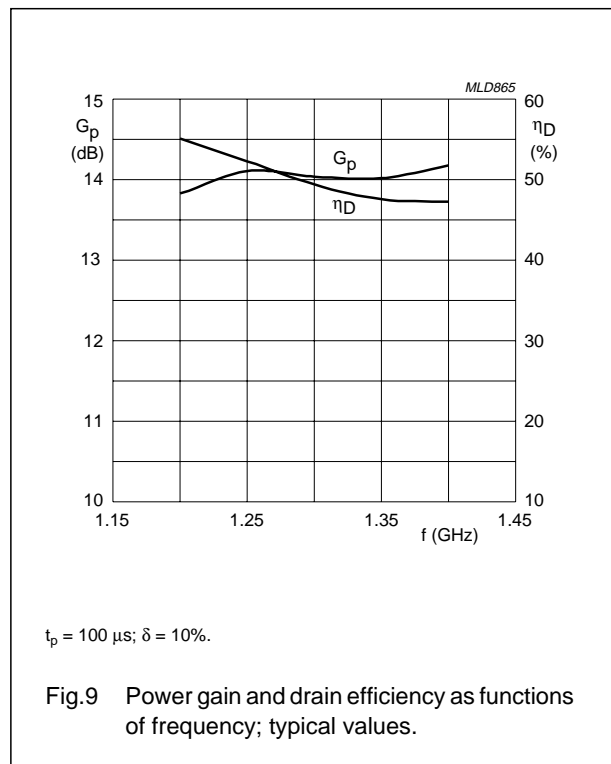
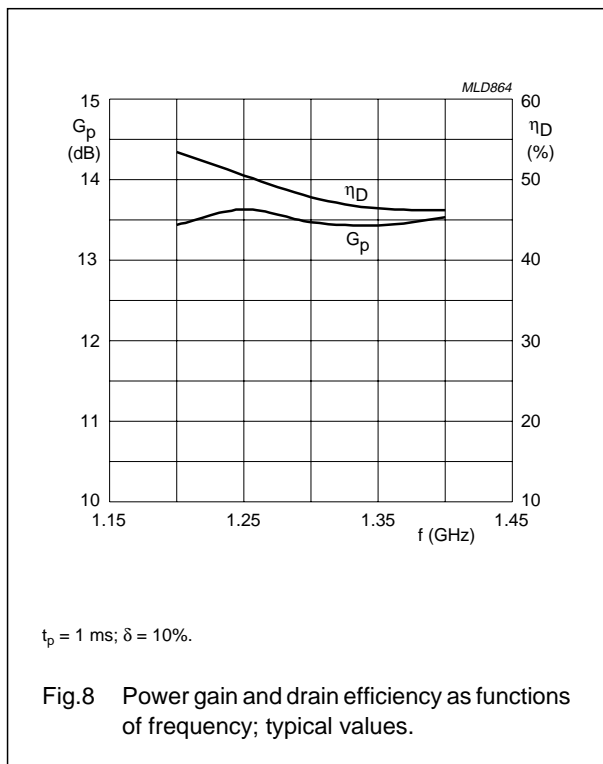
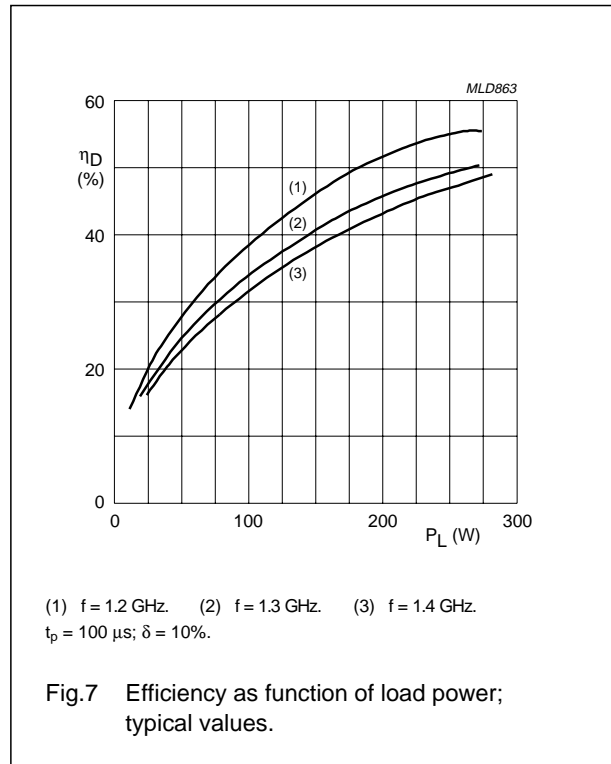
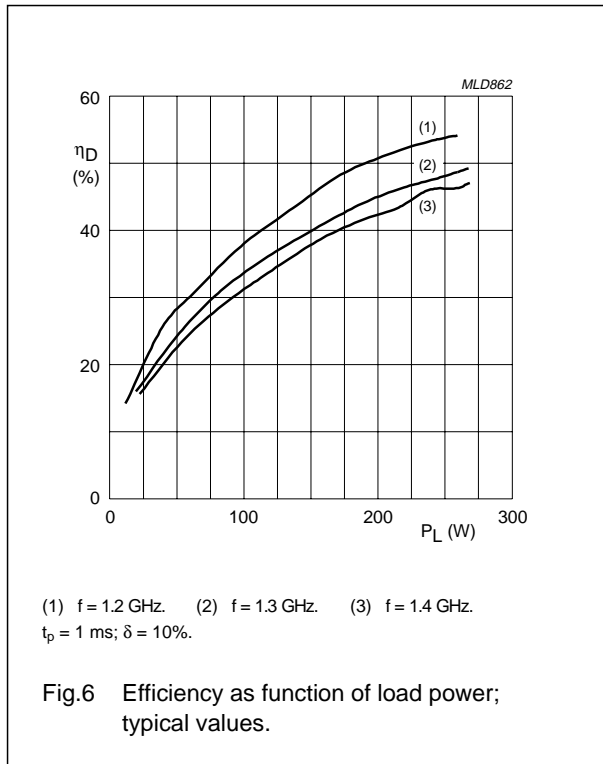
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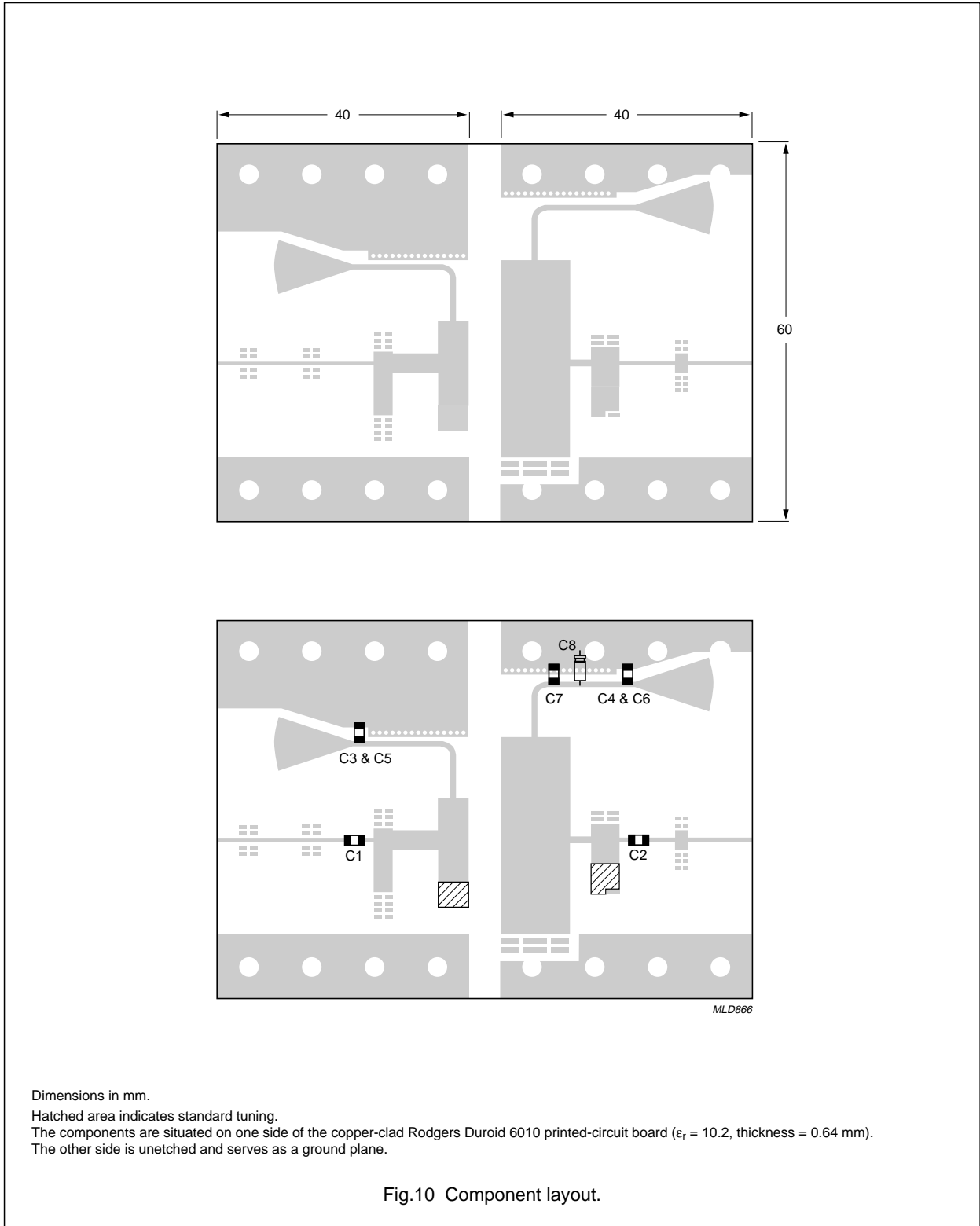
L-band radar LDMOS transistor

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L-band radar LDMOS transistor

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## L-band radar LDMOS transistor

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**List of components** (see Fig.10)

COMPONENT	DESCRIPTION	VALUE	CATALOGUE NO.
C1, C3	capacitor	39 pF	ATC100A
C2, C4	capacitor	47 pF	ATC100A
C5, C6	capacitor	20 nF	ATC200B
C7	capacitor	36 pF	ATC200B
C8	electrolytic capacitor	100 $\mu$ F; 100 V	

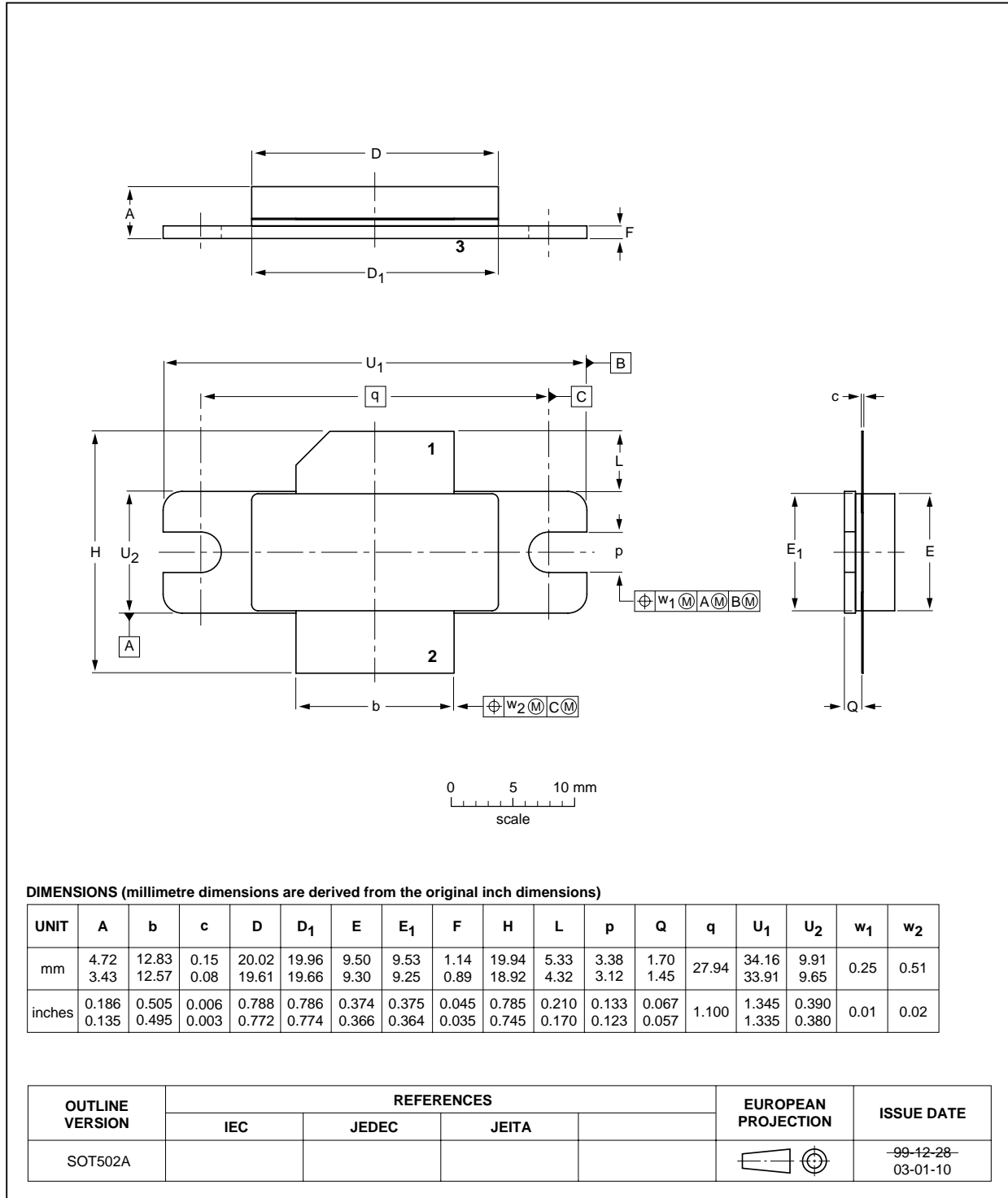
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PACKAGE OUTLINE

Flanged LDMOST ceramic package; 2 mounting holes; 2 leads

SOT502A





## L-band radar LDMOS transistor

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## DATA SHEET STATUS

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Printed in The Netherlands

613524/03/pp10

Date of release: 2003 Aug 29

Document order number: 9397 750 11576

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